Thickness dependence of critical temperature in Mo/Au bilayers

María Parra-Borderías¹, Ivan Fernández-Martínez^{2,3}, Lourdes Fàbrega⁴, Agustín Camón¹, Oscar Gil⁴, José L.Costa-Krämer², Raquel González-Arrabal⁵, Javier Sesé⁶and Fernando Briones².



¹Instituto de Ciencia de Materiales de Aragón (CSIC-Universidad de Zaragoza). C/ Pedro Cerbuna 12, 50009 Zaragoza, SPAIN ²Instituto de Microelectrónica de Madrid (CSIC). C/Isaac Newton 8, E-28760 Tres Cantos, SPAIN ³Instituto de Energía Solar (Universidad Politécnica de Madrid) Avenida Complutense s/n, 28040 Madrid, SPAIN ⁴Institut de Ciència de Materials de Barcelona (CSIC). Campus de la UAB, 08193 Bellaterra, SPAIN ⁵Instituto de Fusión Nuclear (Universidad Politécnica de Madrid) C/José Gutiérrez Abascal, 2, 28006 Madrid, SPAIN ⁶Instituto de Nanociencia de Aragón (Universidad de Zaragoza) C/Mariano Esquillor Edif. I+D, 50018 Zaragoza, SPAIN



ABSTRACT

We report on the sensitivity of the superconducting critical temperature (T_c) to layer thickness, as well as on T_c reproducibility in Mo/Au bilayers. Resistivity measurements on samples with a fixed Au thickness (d_{Au}) and Mo thickness (d_{Mo}) ranging from 50 to 250 nm, and with a fixed d_{Mo} and different d_{Au} thickness are shown. Experimental data are discussed in the framework of Martinis model, whose application to samples with d_{au} above their coherence length is analysed in detail. Results show a good coupling between normal and superconducting layers and excellent T_c reproducibility, allowing to accurately correlate Mo layer thickness and bilayer T_c.

FABRICATION PROCESS

- •High quality, strain-free Mo layers are deposited by RF sputtering at Room Temperature in an UHV chamber on LPCVD Si₃N₄ layers deposited on Si (100) single crystal substrates.
- ■Protective Au layers of 15 nm are deposited insitu by DC sputtering
- •The total Au thickness is obtained by ex situ electron beam evaporation of a second Au layer in another UHV chamber
- •Further details can be found in References [1,2]



Schematic layout (not to scale) of a lithographed bilayer showing top view of the device and a cross section through the central

MARTINIS MODEL

One of the main problems in achieving T_C reproducibility in the Mo/Au system is to control the quality of the interface -> this quality can be checked through the Martinis model [3]

This model predicts T_{C} from simple physical parameters: superconducting layer thickness, d_{S} , normal metal layer thickness, d_{M} , and the quality of the interface, represented by a transmission parameter, t, ranging from 0 to 1.

For arbitrary thick layers:

$$T_{C} = T_{C0} \left[\frac{d_{S}}{d_{0}} \frac{1}{1.13(1+1/b)} \frac{1}{t'} \right]^{b}$$

$$\frac{1}{d_{0}} = \frac{\pi}{2} k_{B} T_{C0} \lambda_{f}^{2} n_{S}$$

$$b = d_{M} n_{M} / d_{S} n_{S}$$

Eq. 1 $\frac{1}{t} \rightarrow \frac{1}{t} + \frac{1}{3} \left(\frac{d_S}{0.013 \mu m} \frac{\rho_S}{\rho_{S0}} + \frac{d_M}{0.084 \mu m} \frac{\rho_M}{\rho_{M0}} \right)$

<u>Problem:</u> This model does not reproduce the expected T_c saturation for $d_M > \xi_M[4]$

Conclusions

- Fabricated Mo/Au thermometers display excellent coupling, T_C and reproducibility.
- •To avoid an underestimation of the transparency factor, only the "active" metal thickness $(d_{Au}=\xi_M)$ has to be considered.
- ■For thick layers $(d_M \ge \xi_M)$ The following constrain $d_{A_M} = \xi_M$ has to be applied in order to apply the model developed by Martinis et al.[3].
- Since d_M≥ξ_M, R_N can be tunned through variations of d_M without affecting T_C

This work has been carried out with financial support from the Spanish MICINN (projects ESP2006-13608-C02, AYA2008-00591/ESP,

BILAYER CRITICAL TEMPERATURE AS A FUNCTION OF

- Bilayers with normal metal layer thickness of d_{au} =215 and 115 nm and variable superconducting thickness, d_{Mo} , are
- ■Excellent T_C reproducibility (ΔT_C≈20 mK) which allow accurate determination of T_C as a function of d_{Mo}
- ■No change in T_C is observed when d_{AU} is increased between 115 nm and 215 nm ->

ξ_M can be estimated as [5]:



Au grain size is governed by the Mo one [5]→I_M can be estimated as ~20 nm [1]

$$\xi_M \sim 107 \ nm$$

When fitting experimental data to Eq. 1 different interface transparency values are found for d_{Au}= 115 nm and 215 nm: t decreases as d_{Au} increases

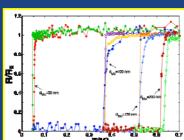
HRXTEM images show changes neither in interface nor in grain size as a function of Au layer thickness \rightarrow the necessary change in tthat has to be introduced in (1) to fit experimental data has no physical meaning. This indicates that some assumption have to be done in order to validate the model for thick

Since the Au thickness above ξ_M is not influencing T_C, to used Eq.1 in bilayers of arbitrary thickness we propose that Martinis Eq. can be used when $d_{Au} > \xi_M$ simply by substituting d_{Au} by ξ_M

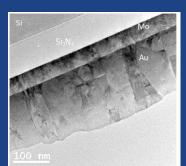
Under this assumption, a unique fit to $T_C(d_{Mo})$ and a unique t value can be obtained for different dAu:

t~0.45 ±0.08

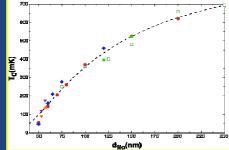




bilayers covered by d. =115 nm.



Cross section TEM image of a 50/200 nm Mo/Au bilayer



 $T_{_{\rm C}}$ of Mo/Au bilayer as a function of the superconductor thickness for a normal metal thickness of 115 nm (empty symbols) and 215 nm (full symbols). Each symbol corresponds to a set of bilayers. Dash line correspond to the fitting of the data to Eq. 1.

Our samples are extremely reproducible, and display and excellent coupling between the involved layers.

- Fabrega et al. IEEE Transactions on Applied Superconductivity, 19, 460 (2009).
 M. Martinis et al. Nuclear Instruments and Methods in Physics Research A, 444, 23 (2000).
 Werthamer, Physical Review, 132, 440 (1963).